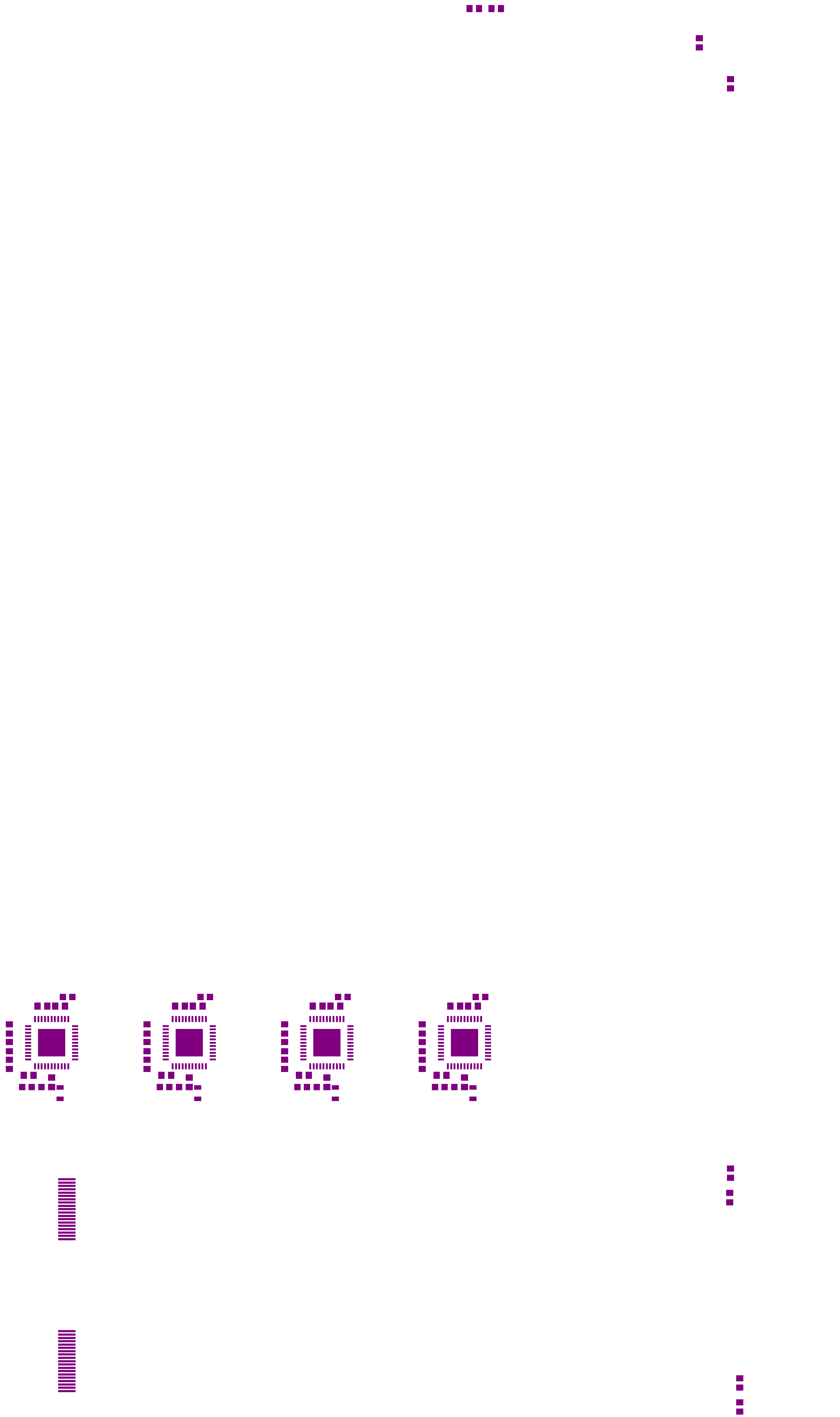
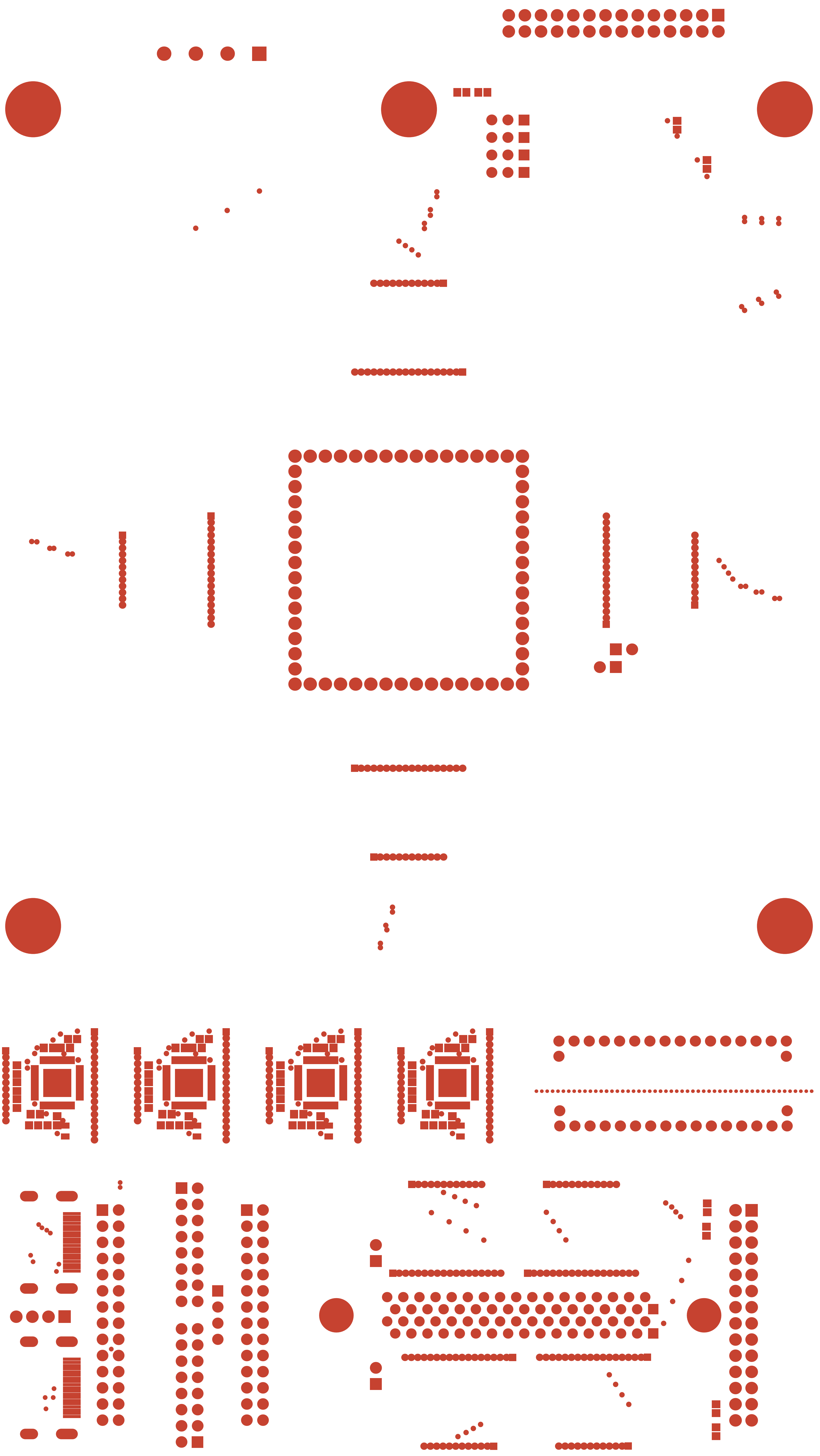
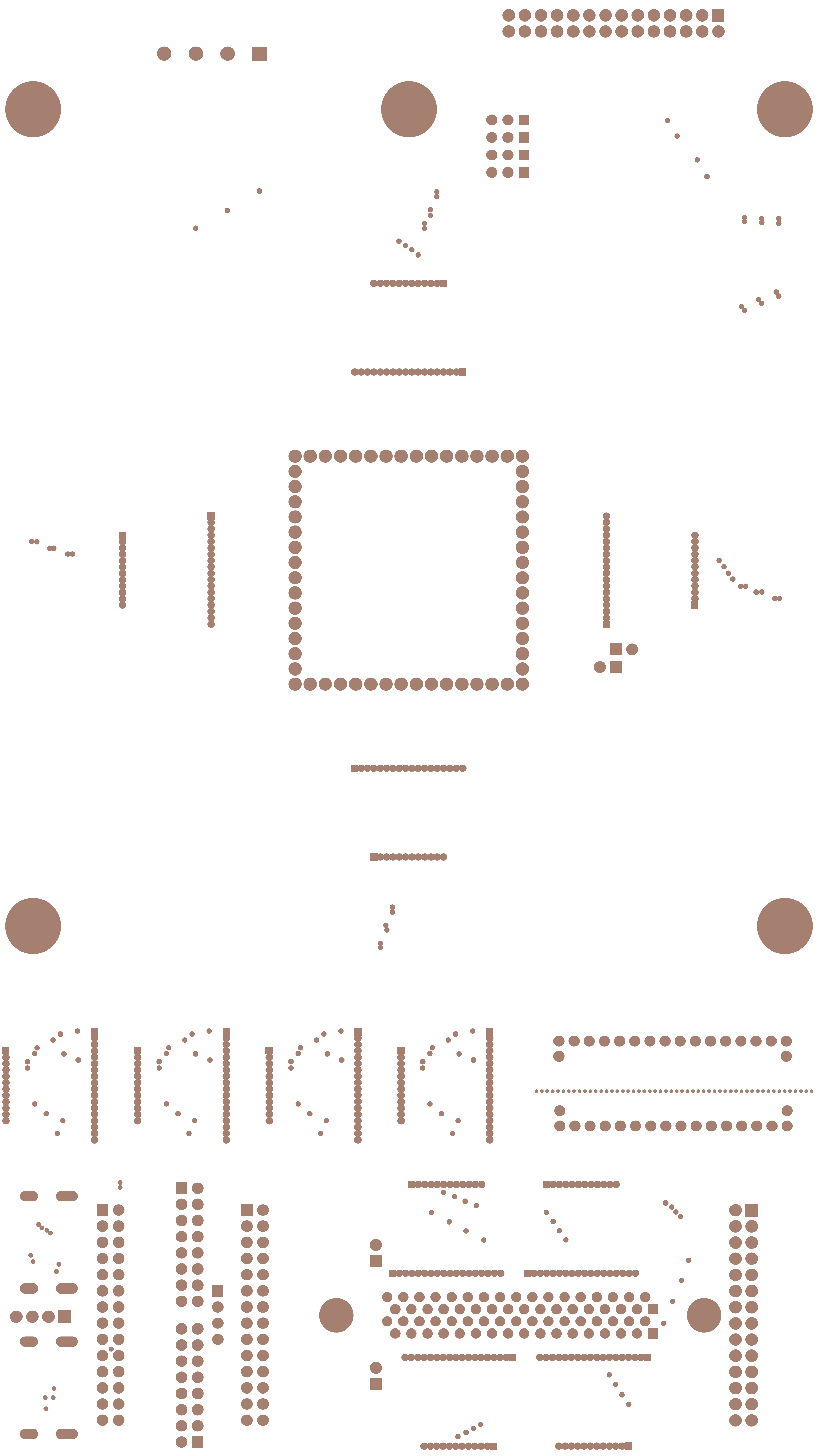


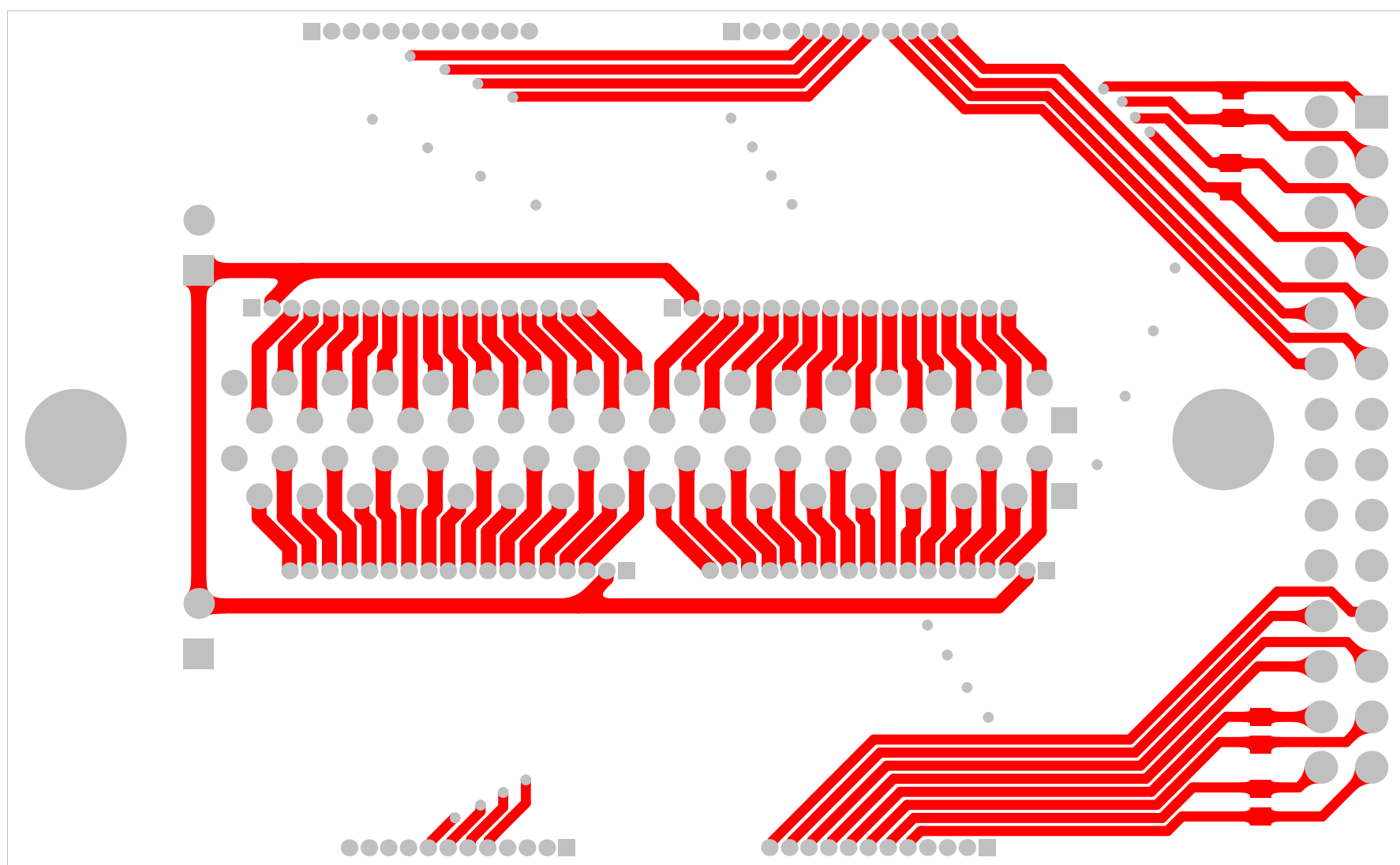
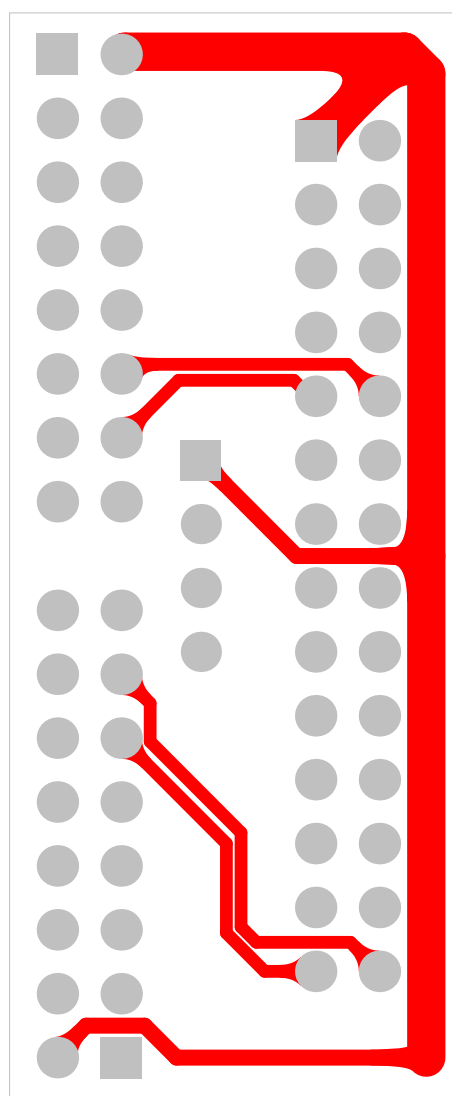
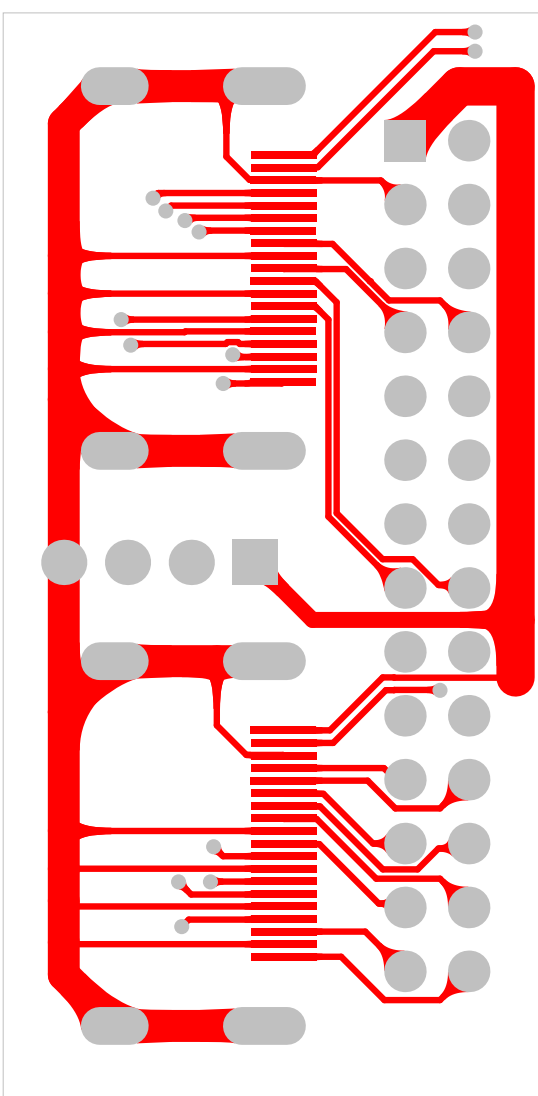
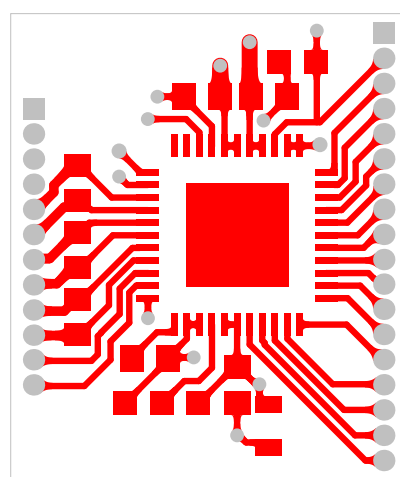
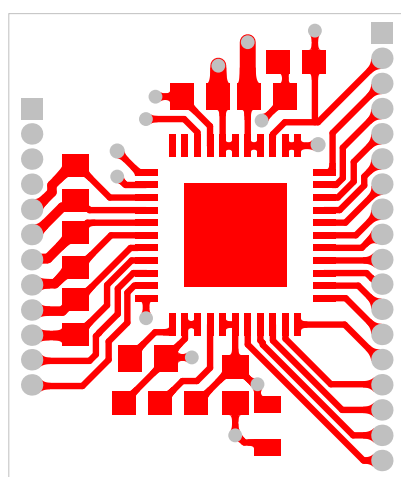
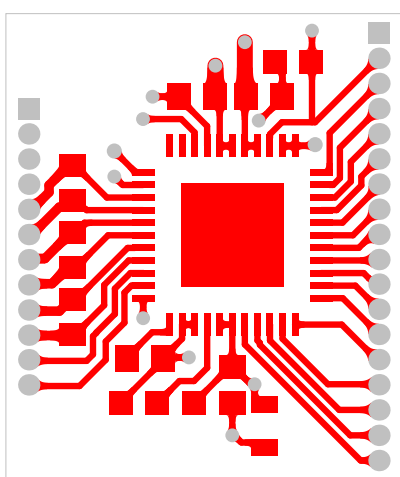
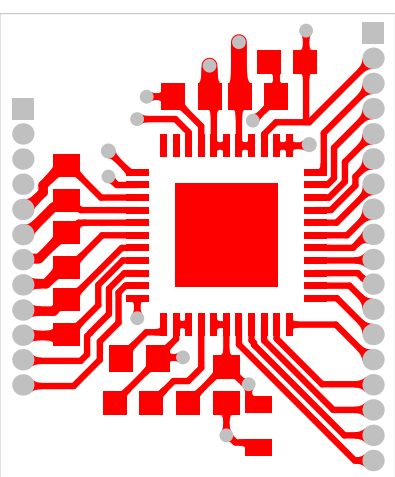
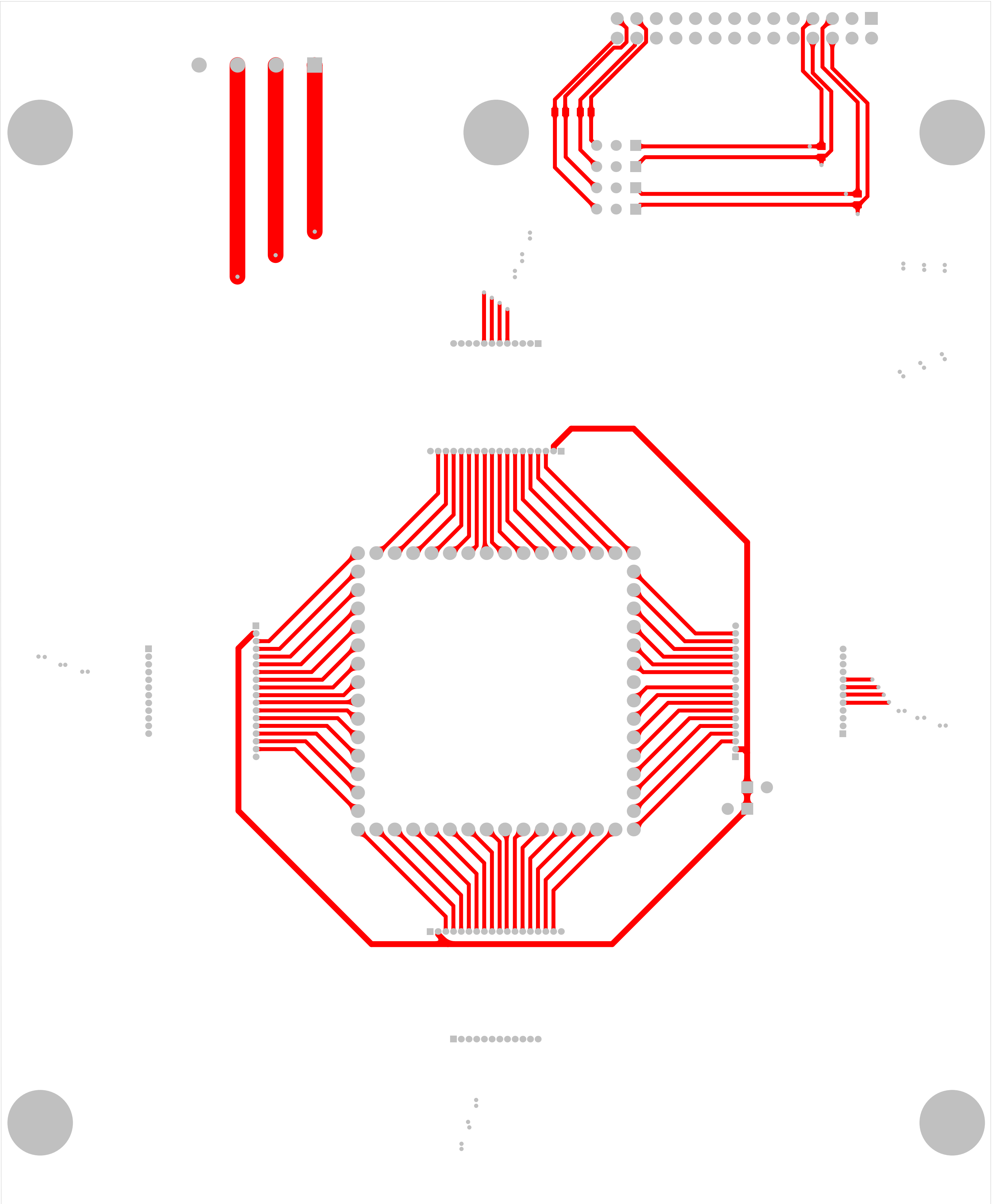
Board Stack Report

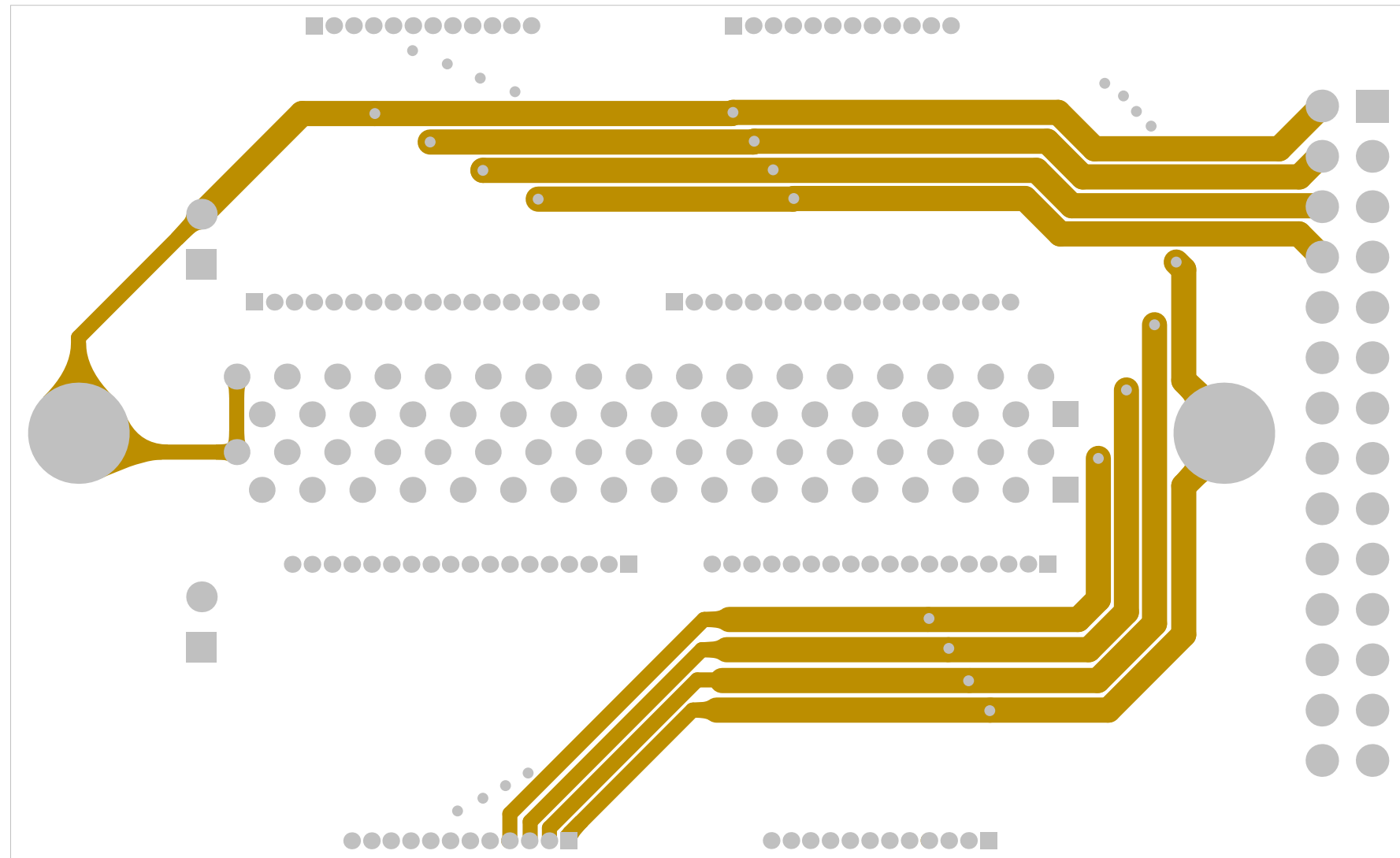
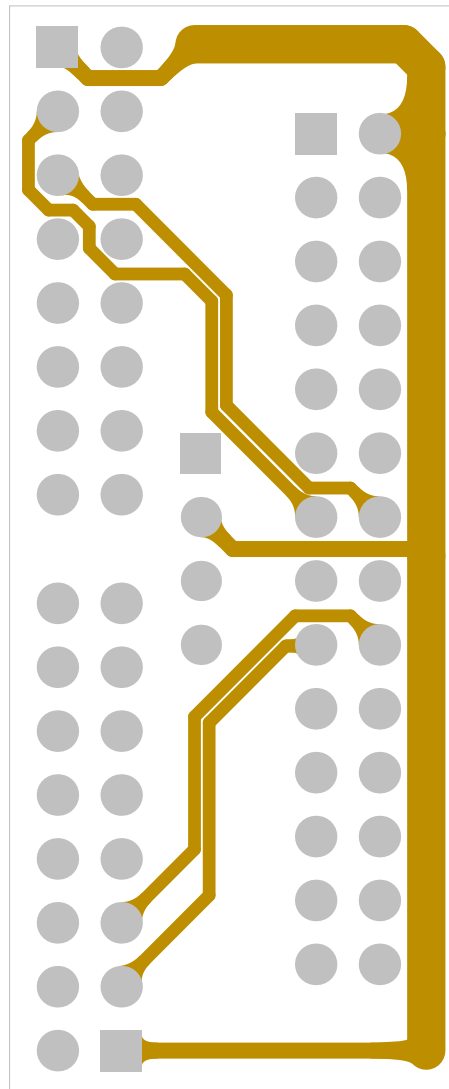
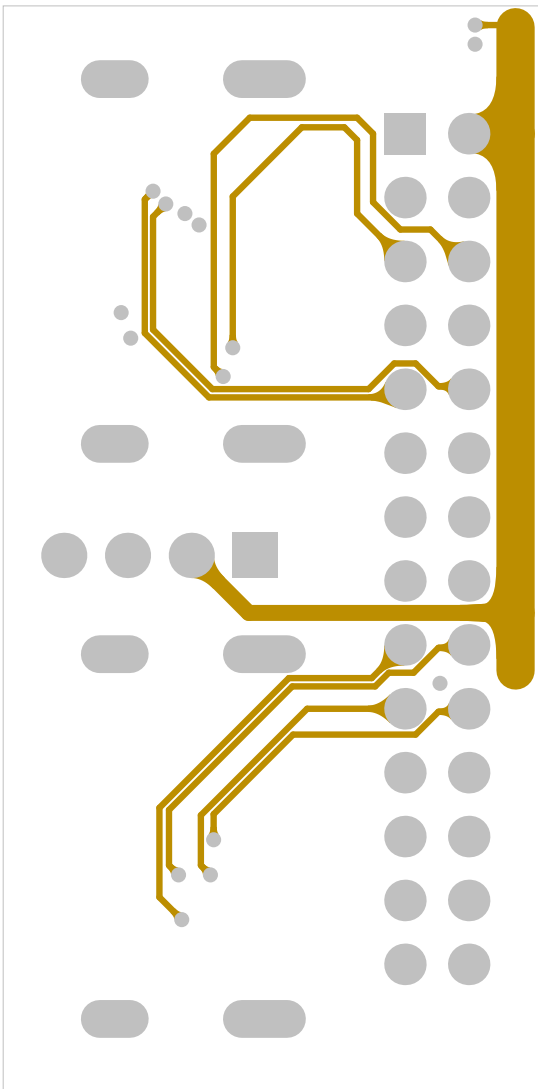
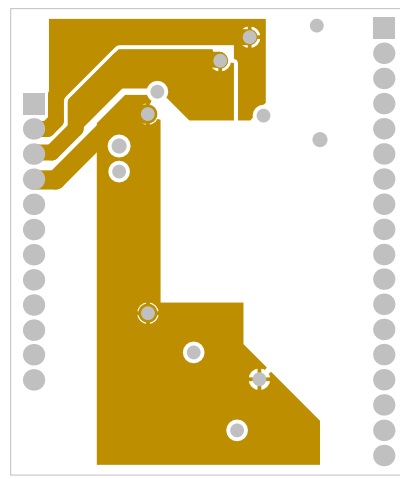
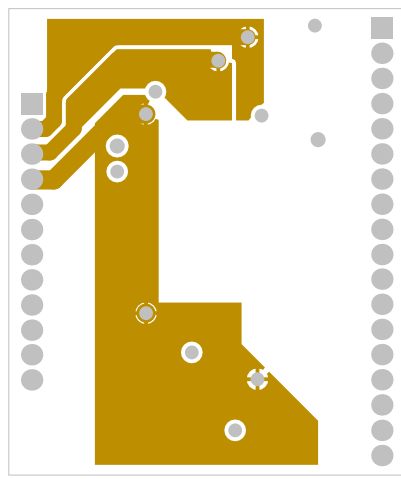
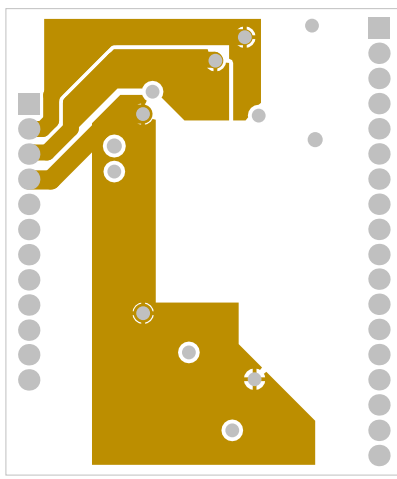
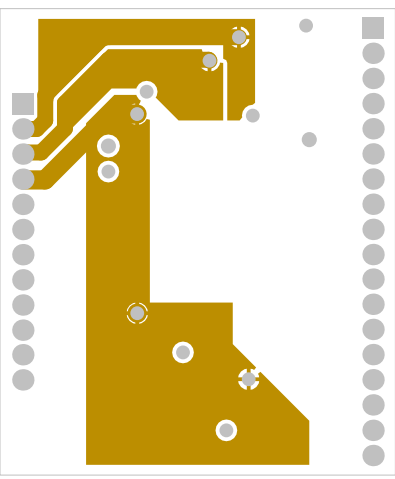
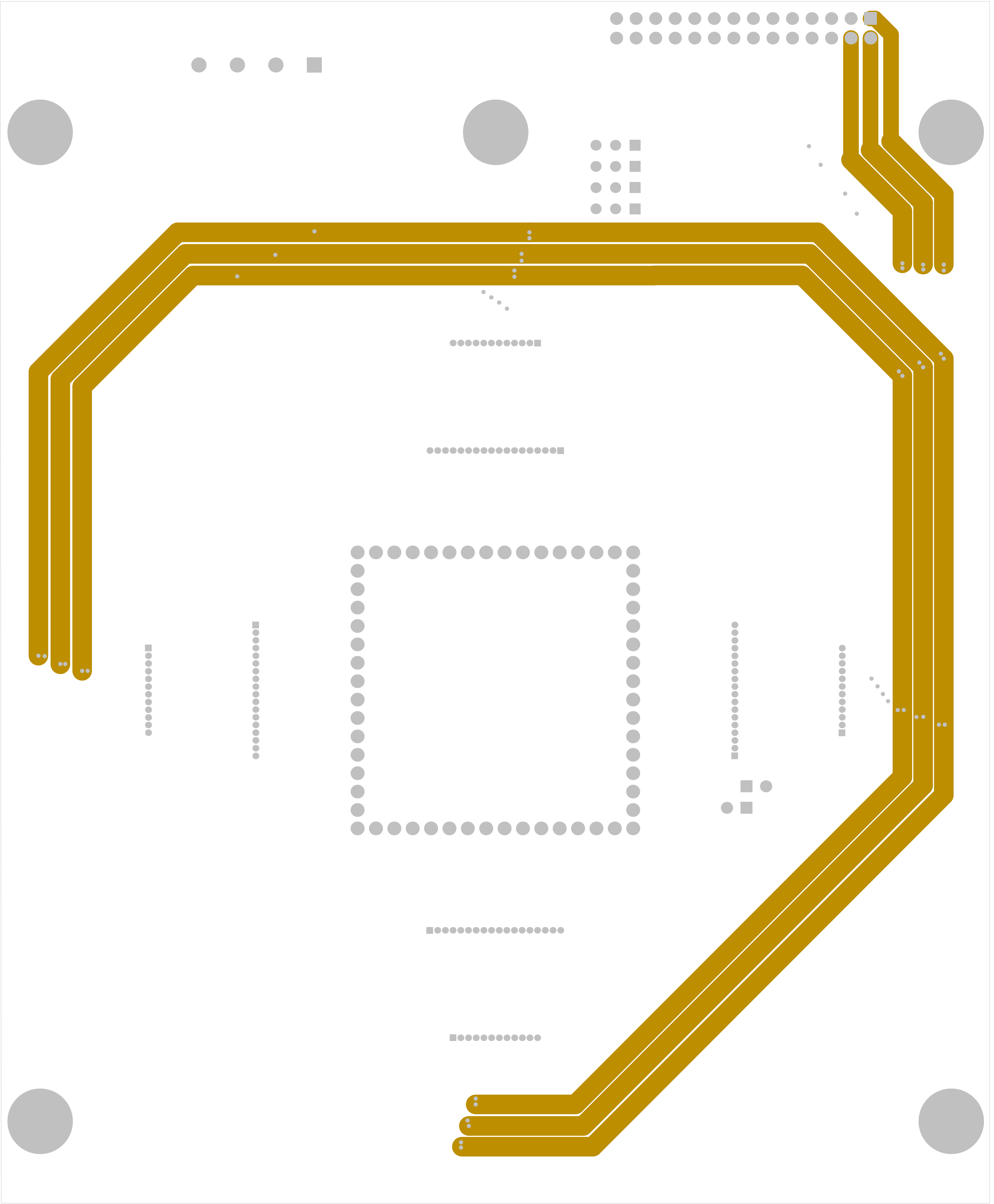
Stack Up		Layer Stack			
Layer	Rigid FR4 4 layers 1.6mm thick 1 oz copper	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Copper Layer	Copper	0.035mm	
5		Dielectric 1	FR-4	0.220mm	4.2
6		Internal Copper Layer 1	Copper	0.035mm	
7		Dielectric 2	FR-4	1.000mm	4.2
8		Internal Copper Layer 2	Copper	0.035mm	
9		Dielectric 3	FR-4	0.220mm	4.2
10		Bottom Copper Layer	Copper	0.035mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
Height : 1.600mm					

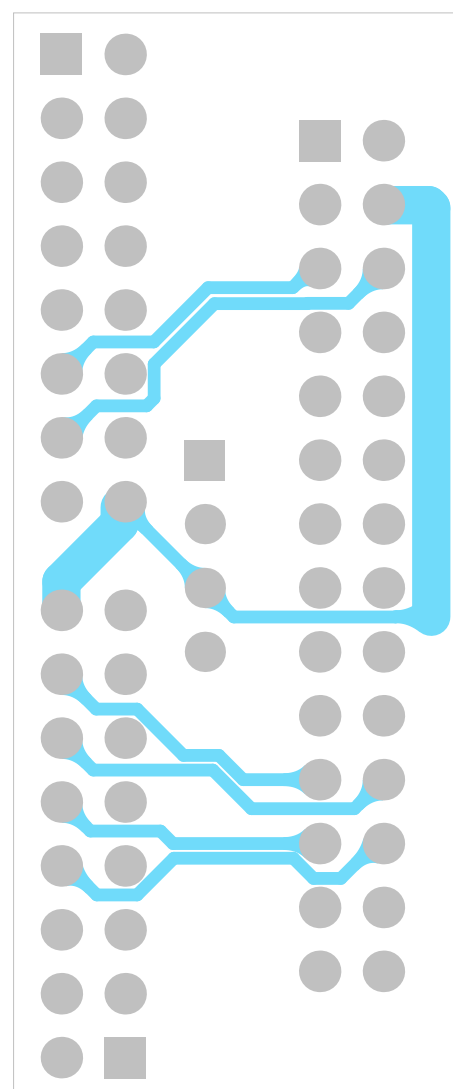
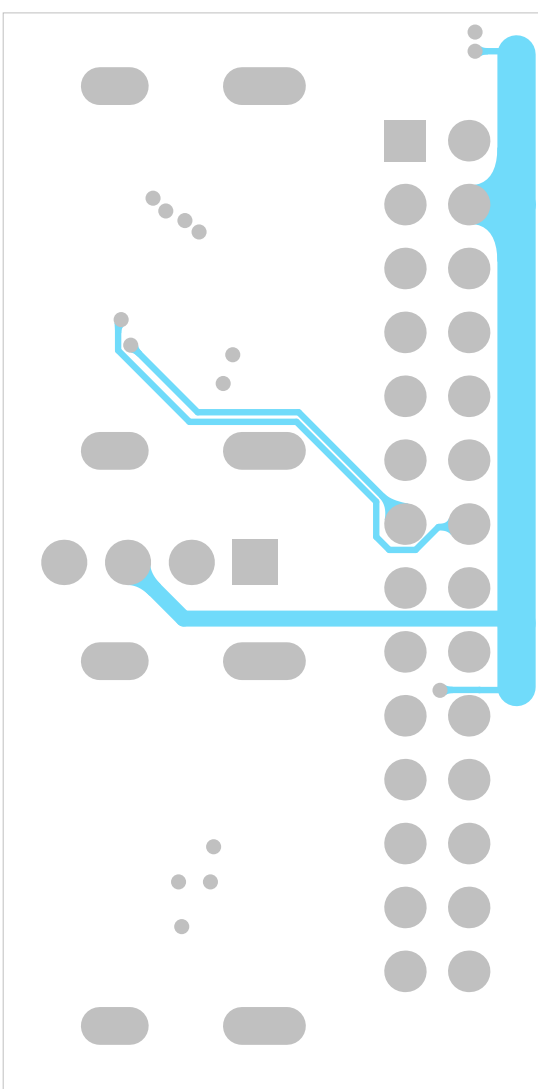
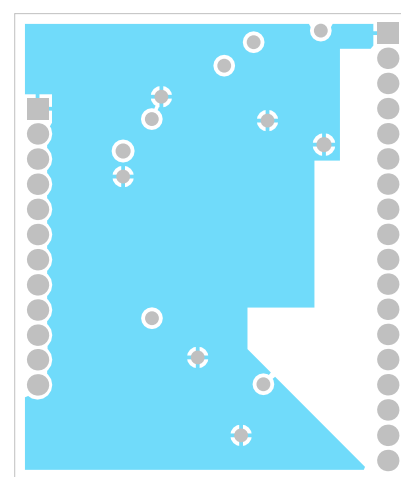
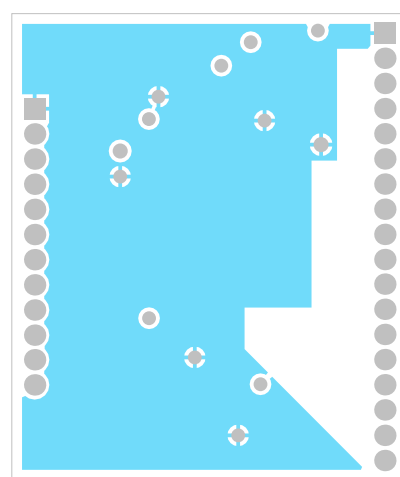
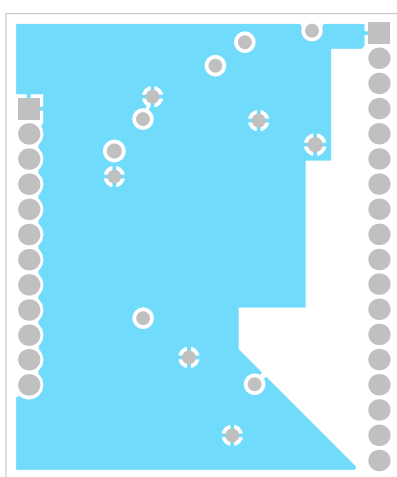
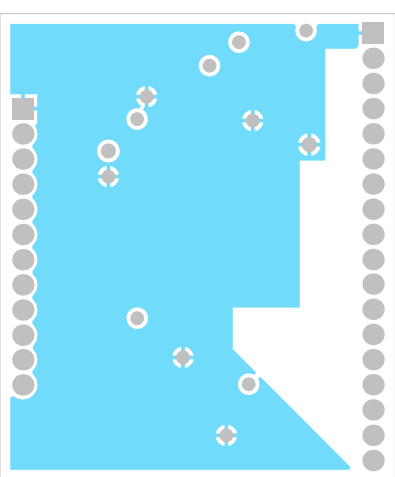
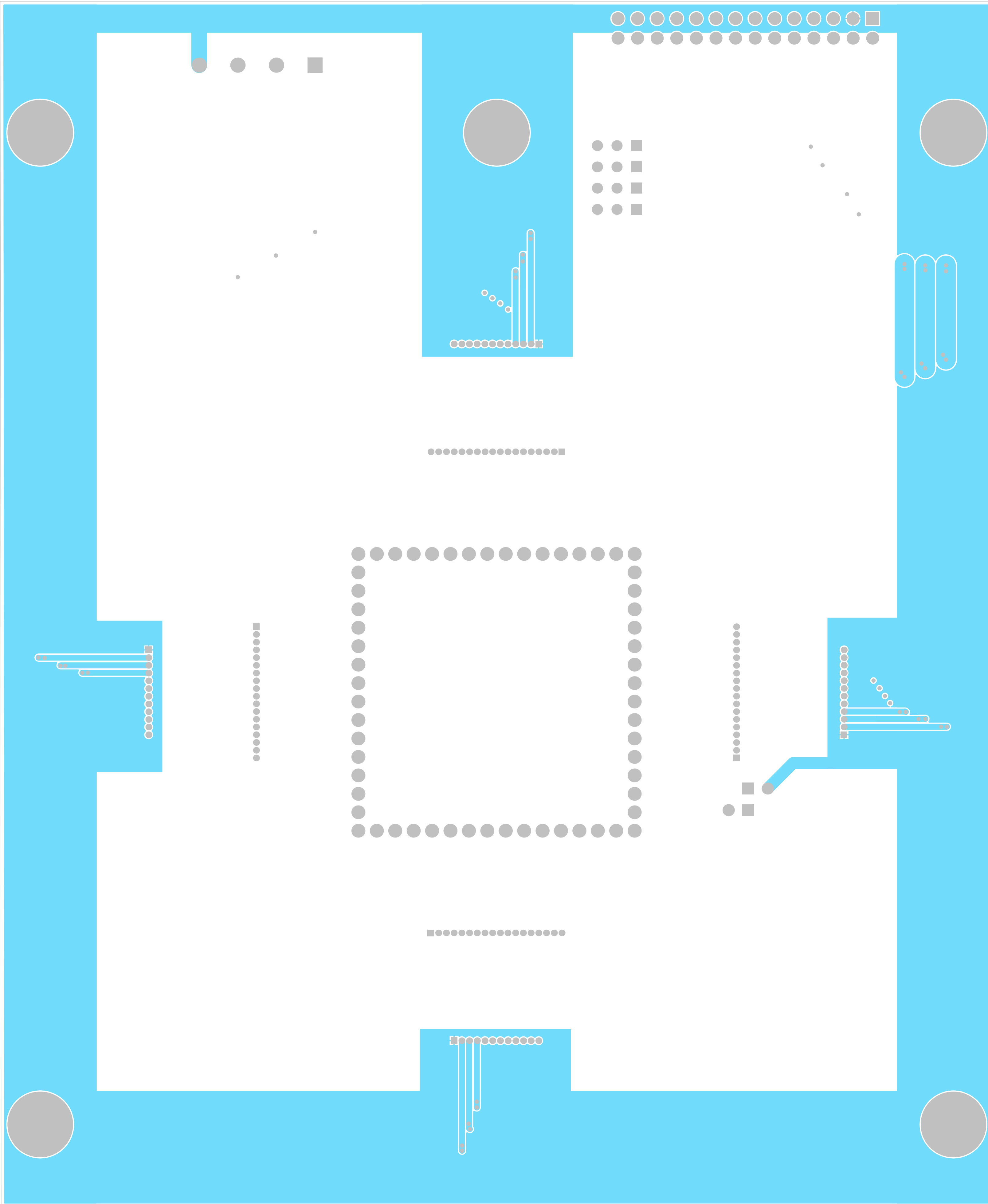


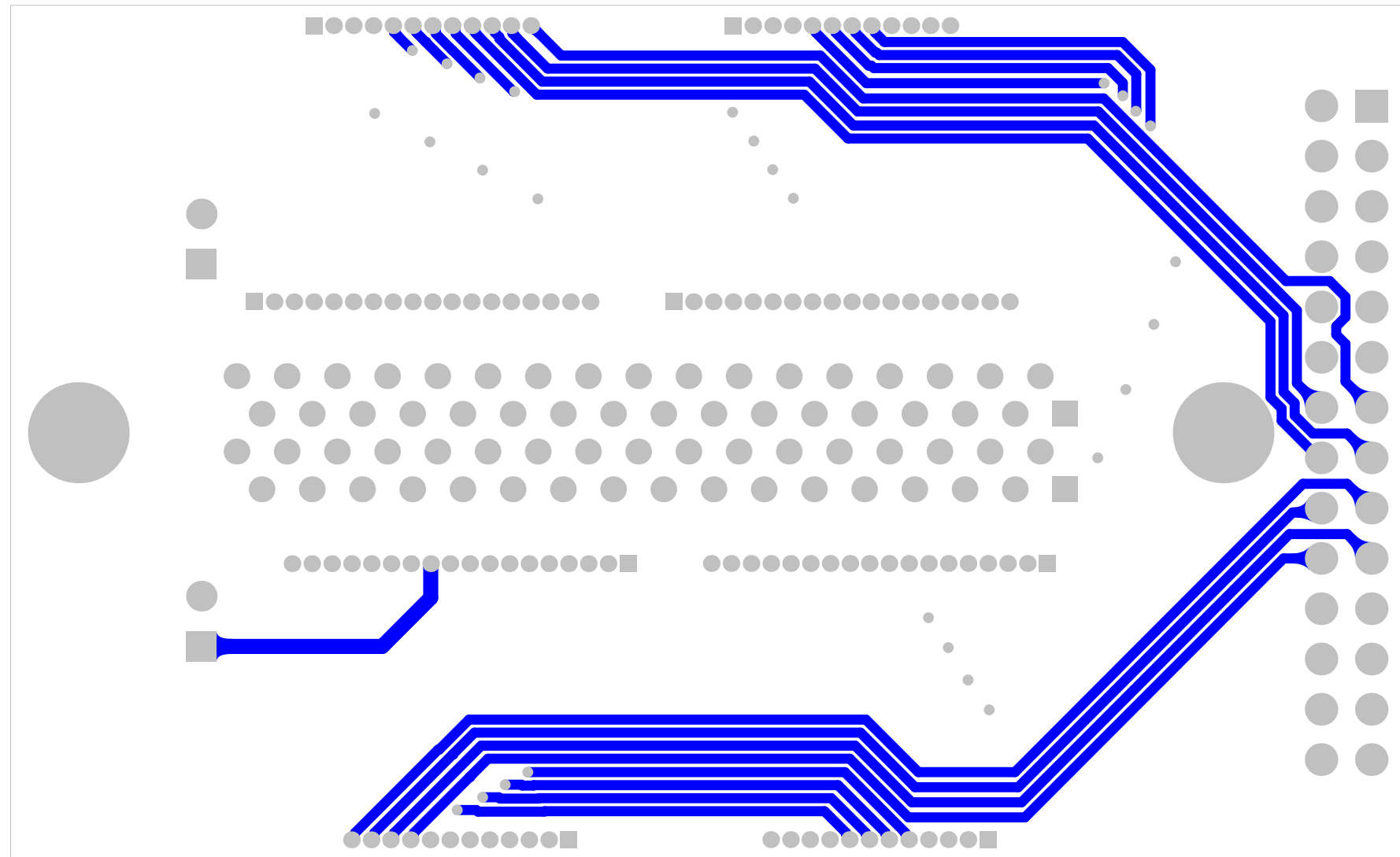
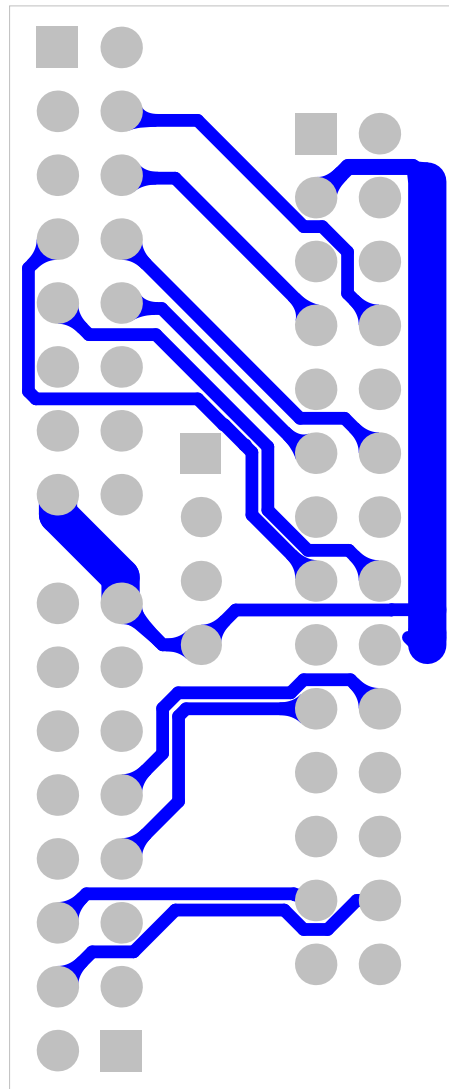
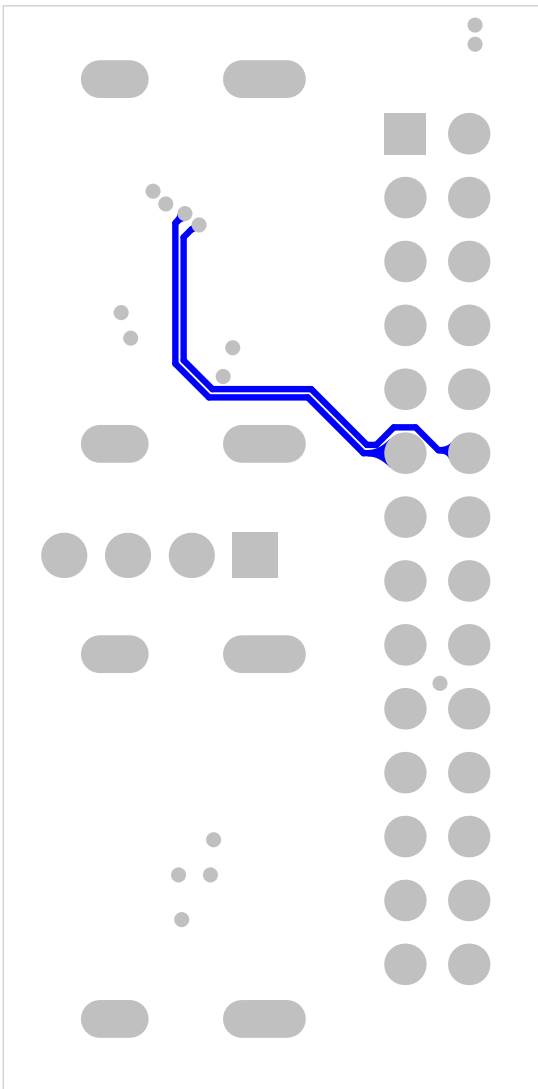
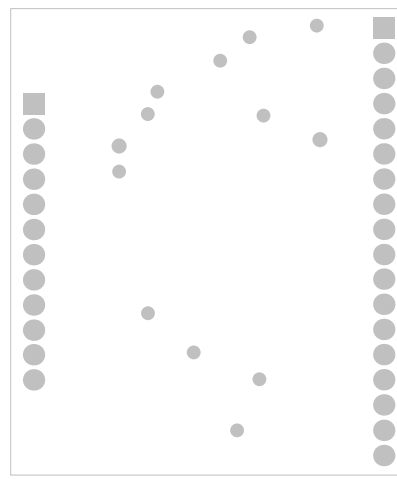
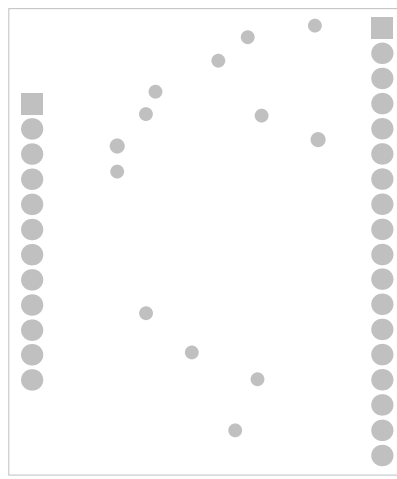
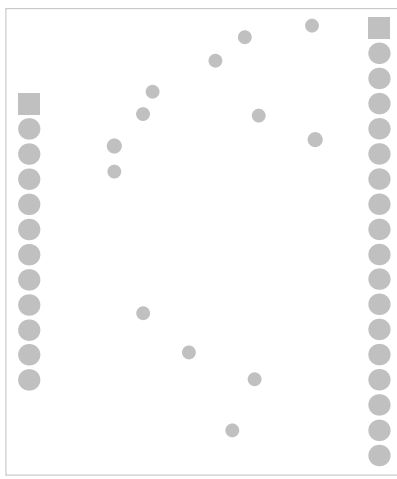
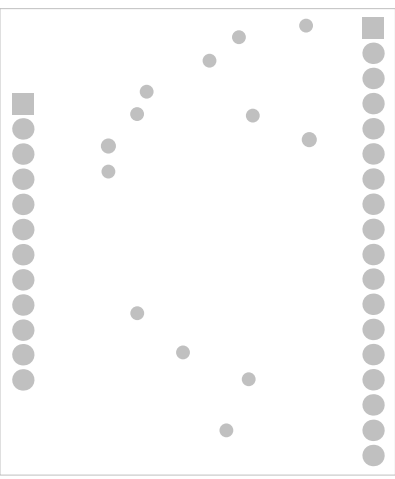
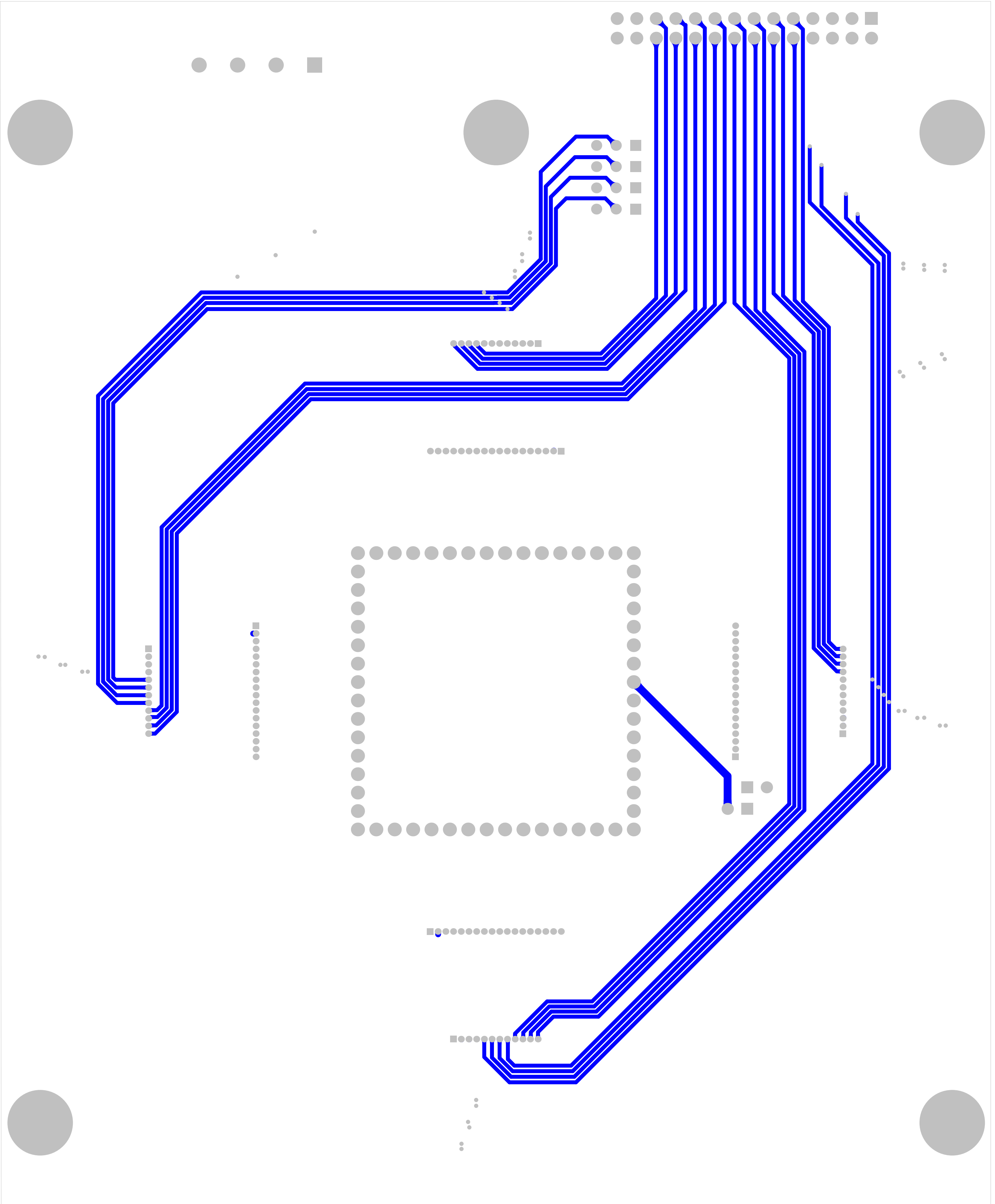


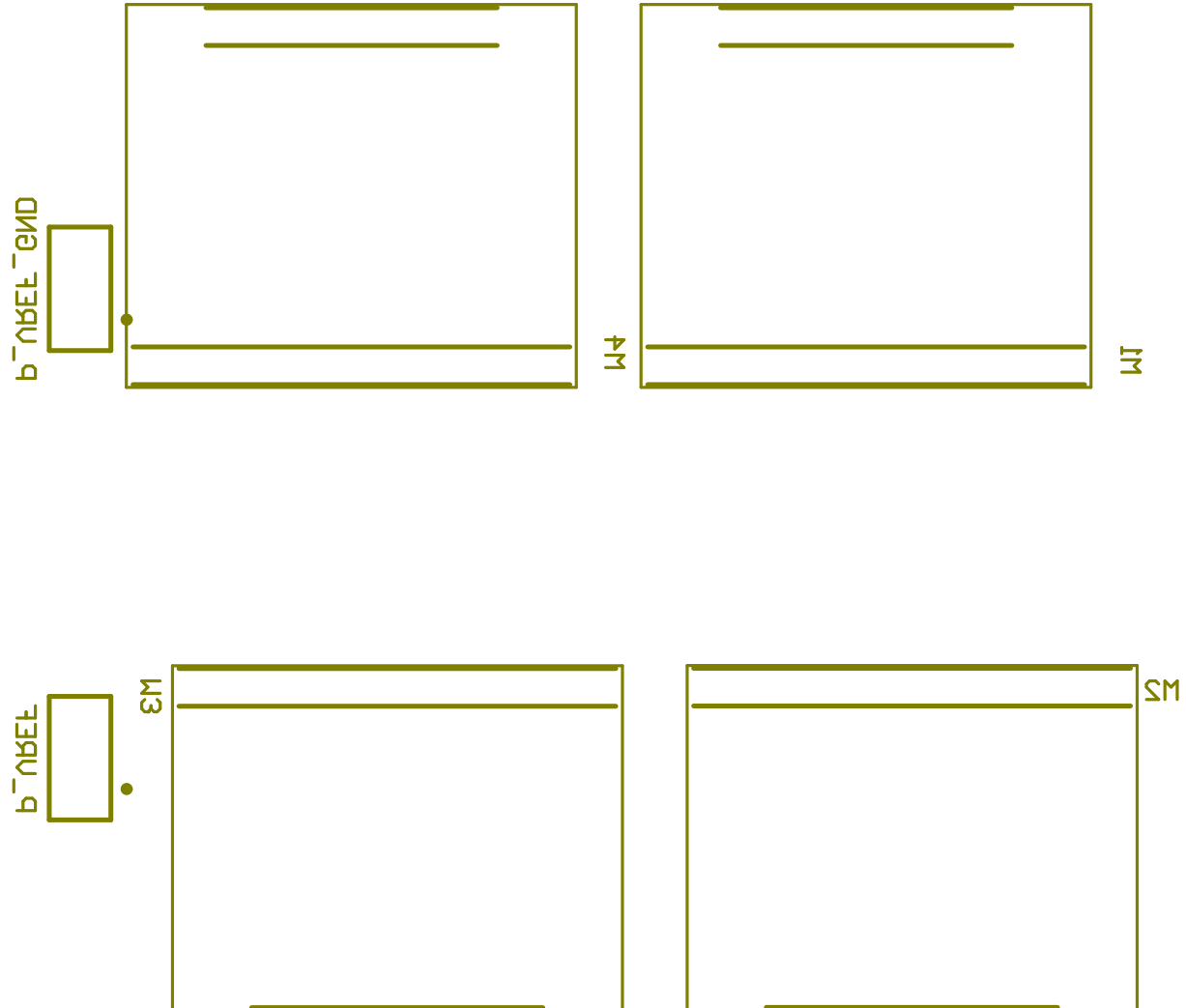


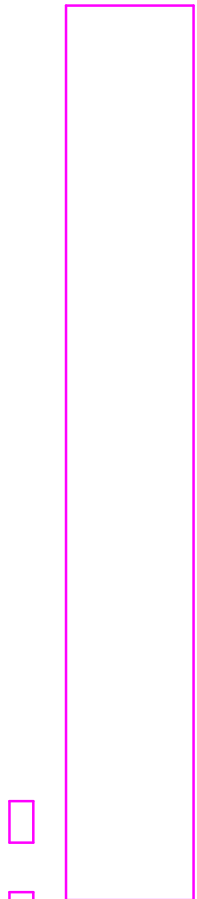
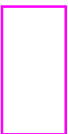
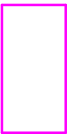
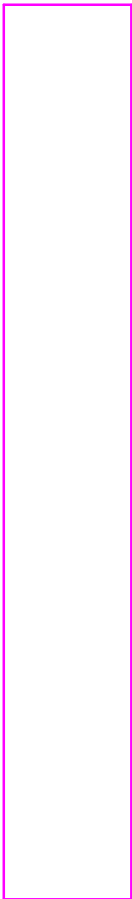
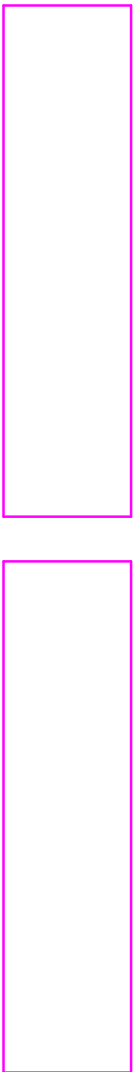
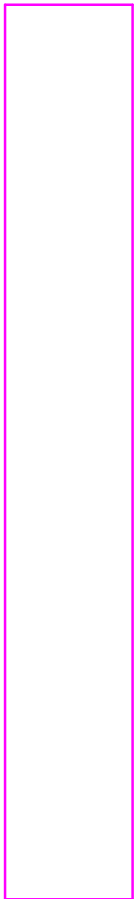
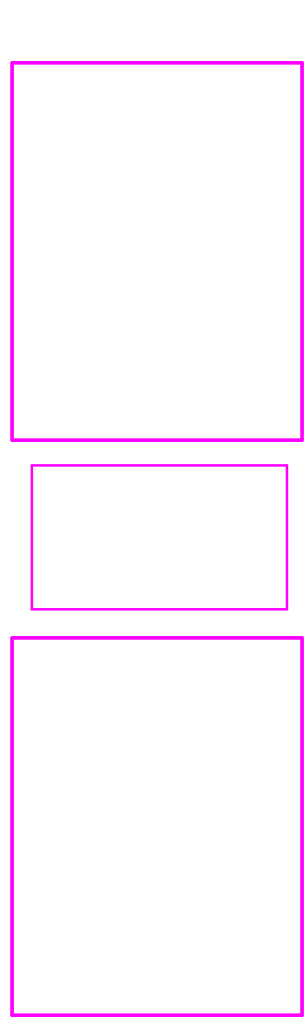
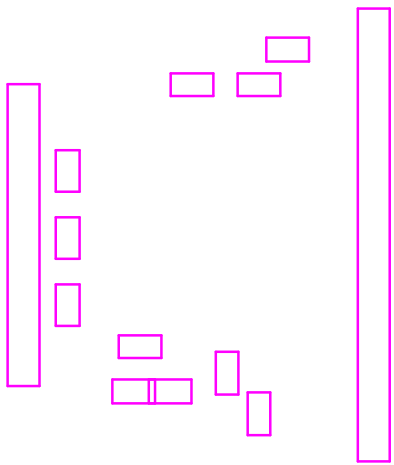
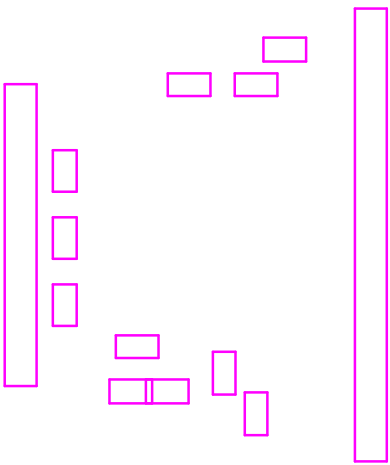
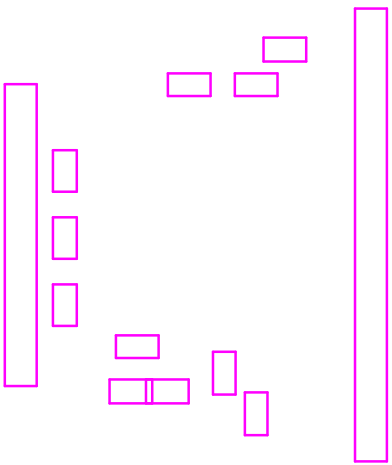
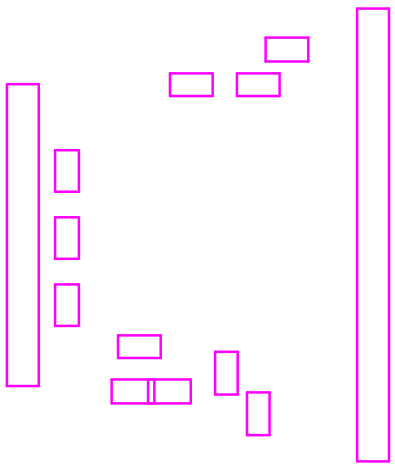
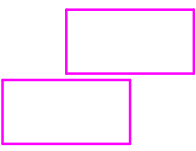














+

+

+

+

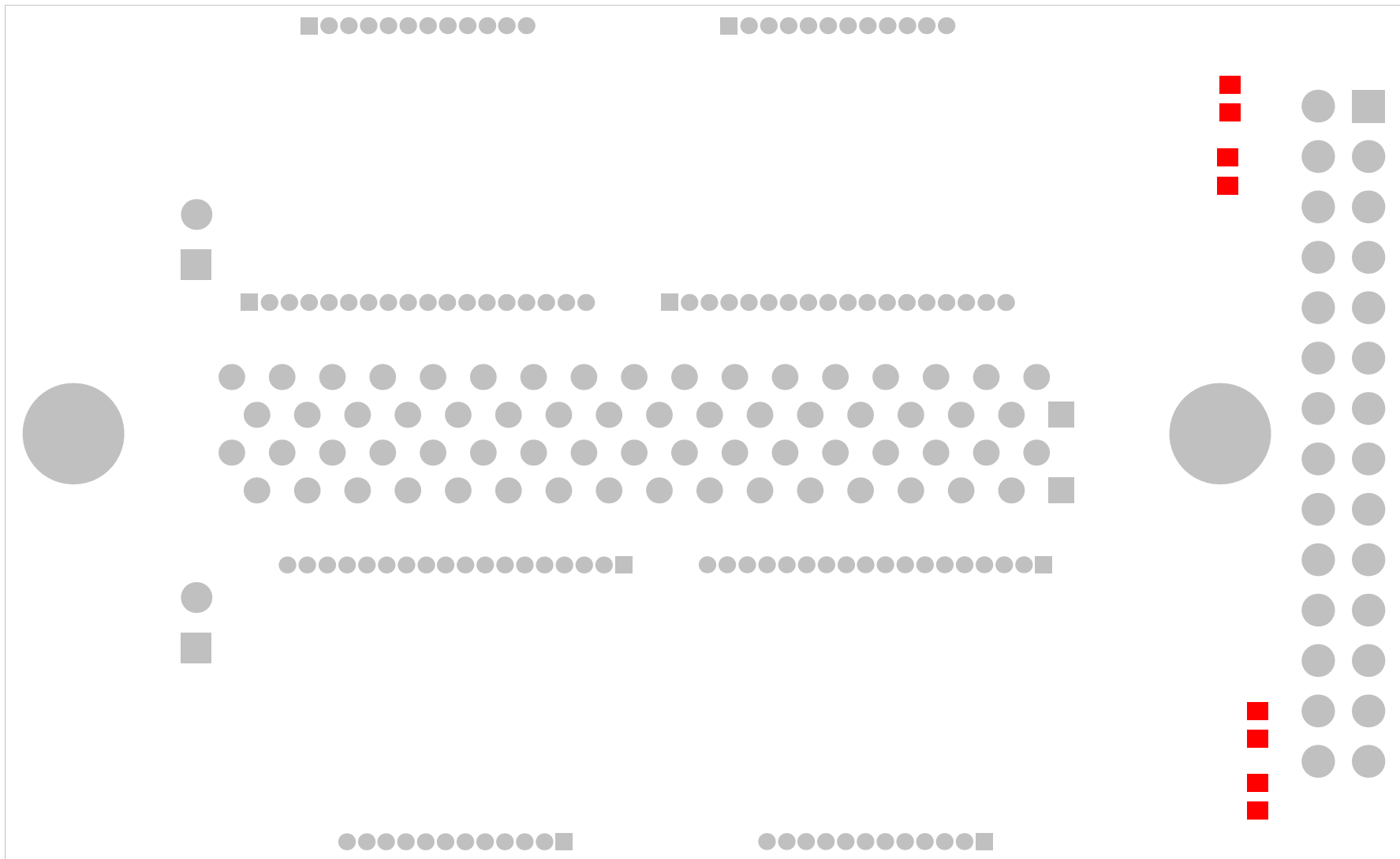
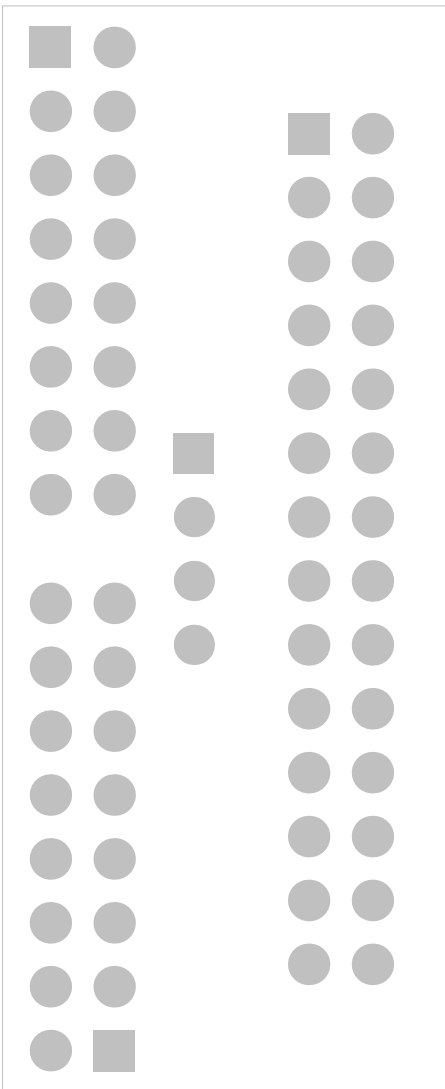
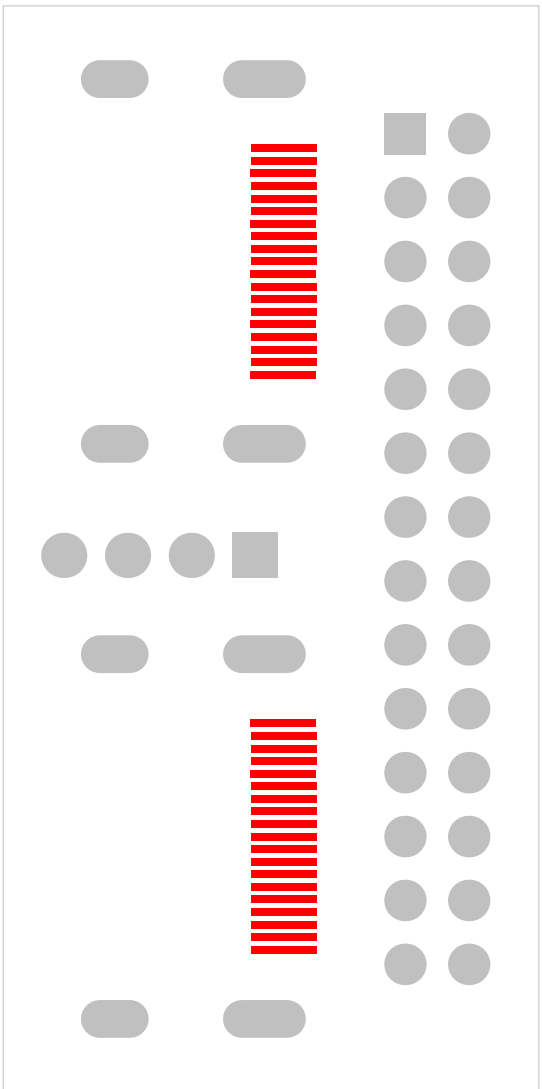
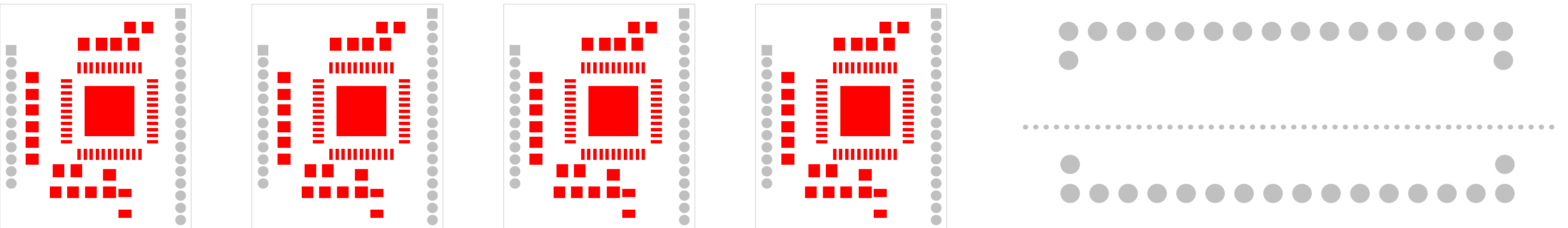
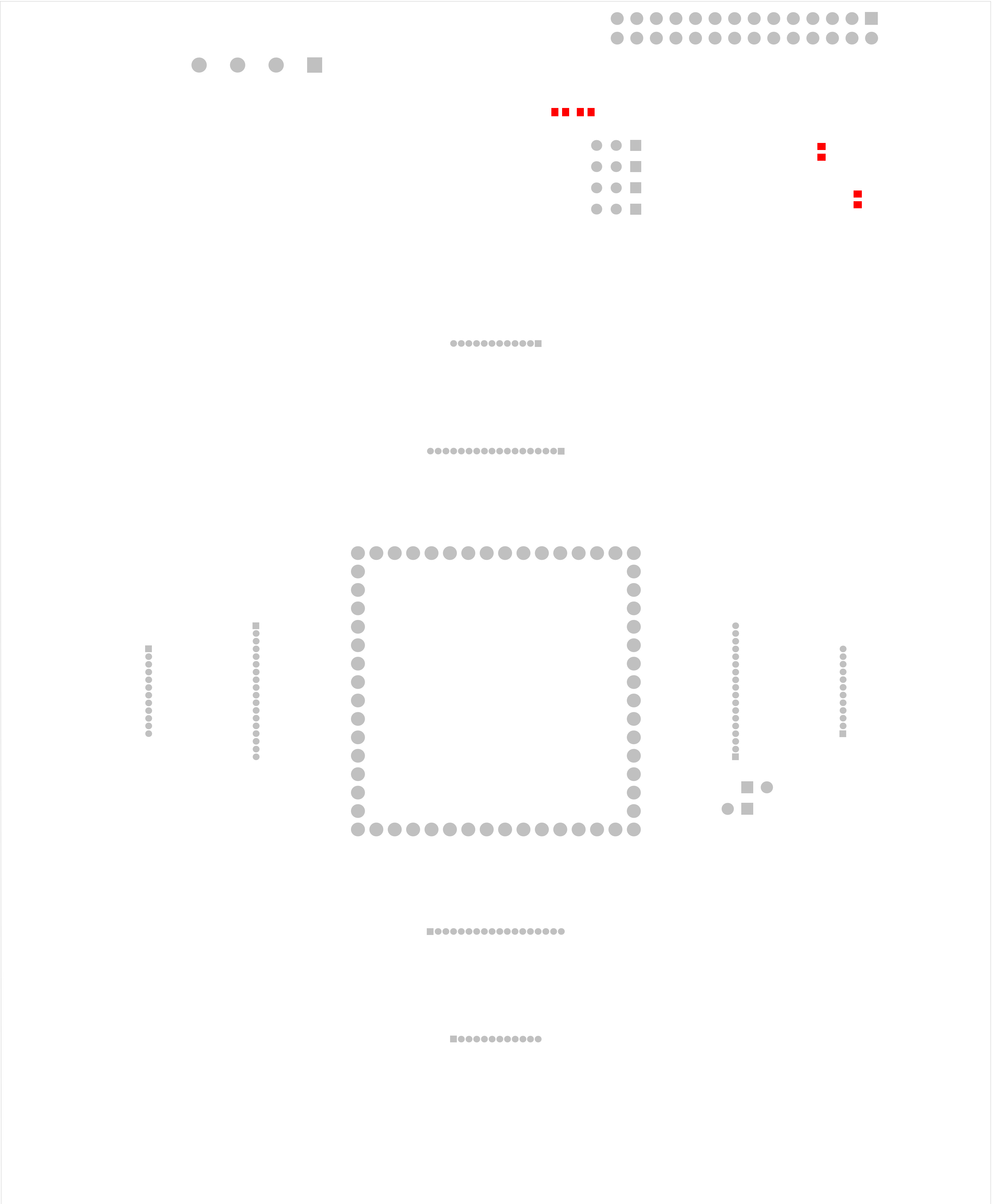
+

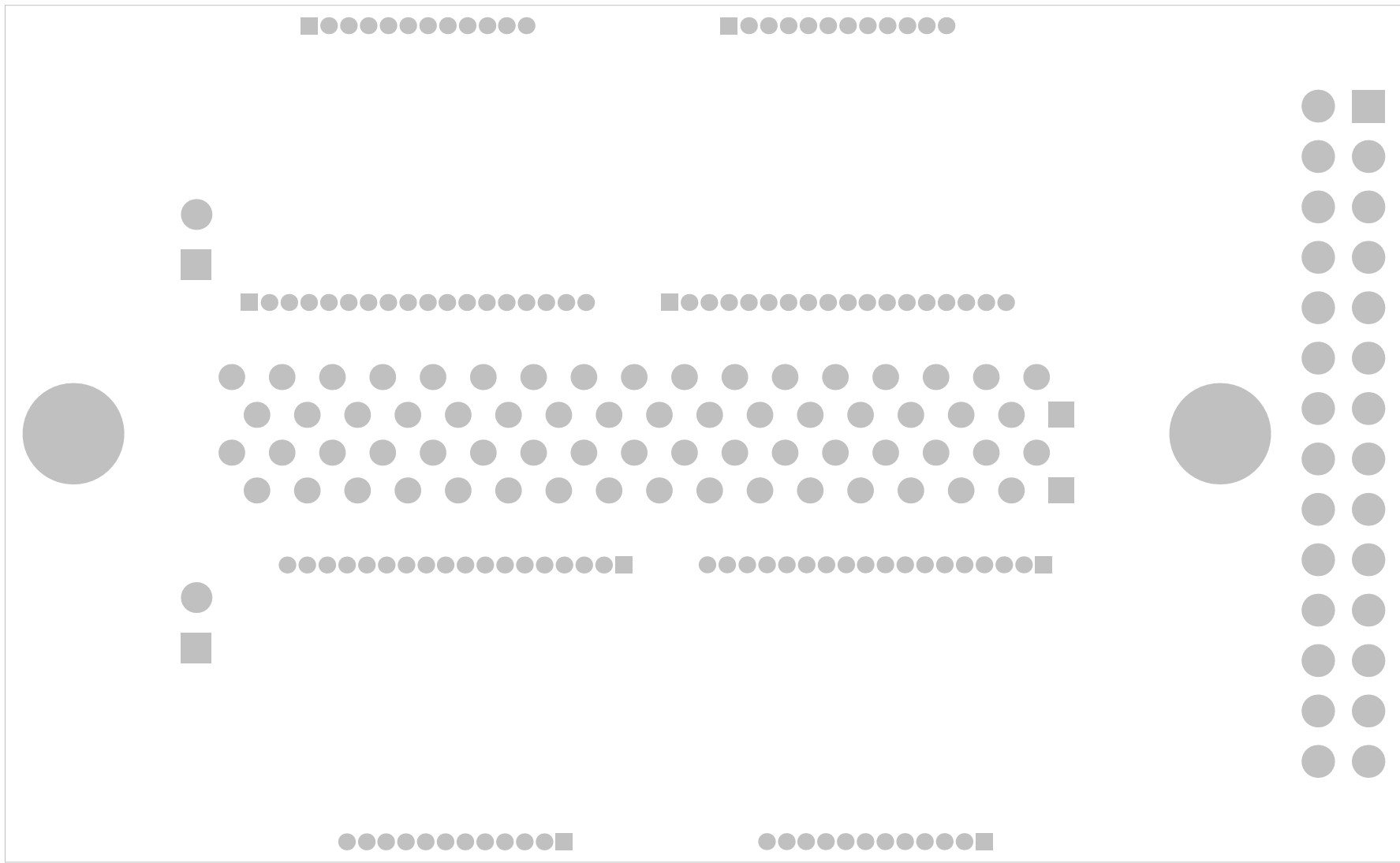
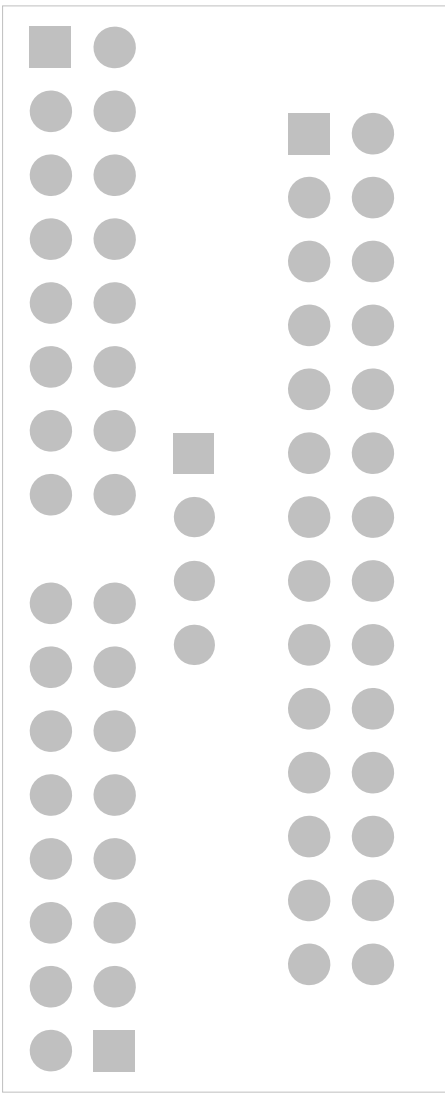
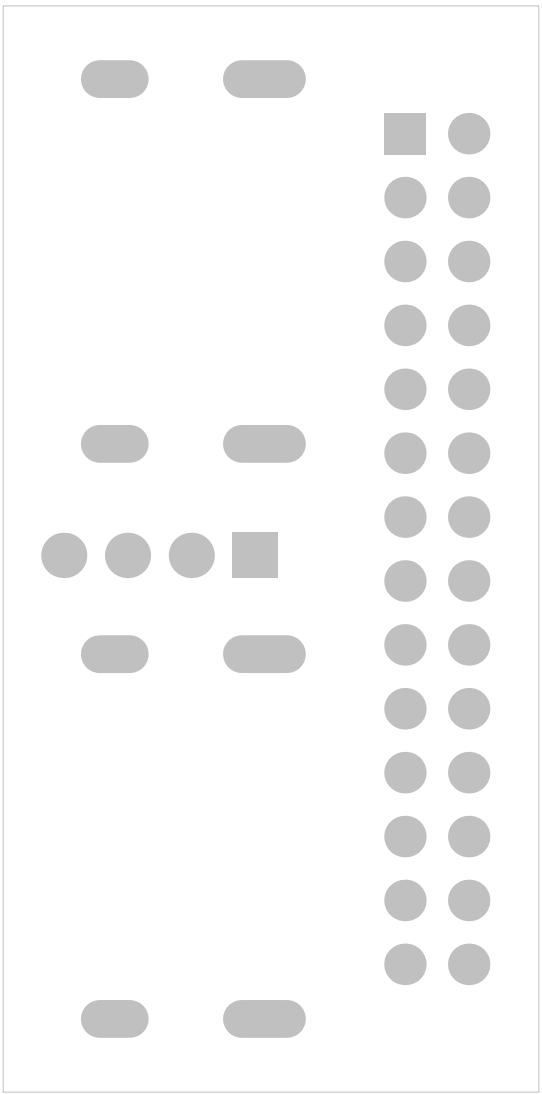
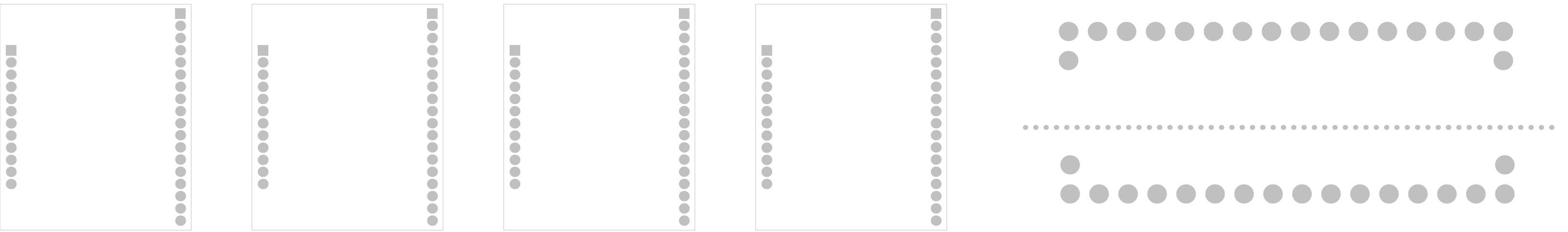
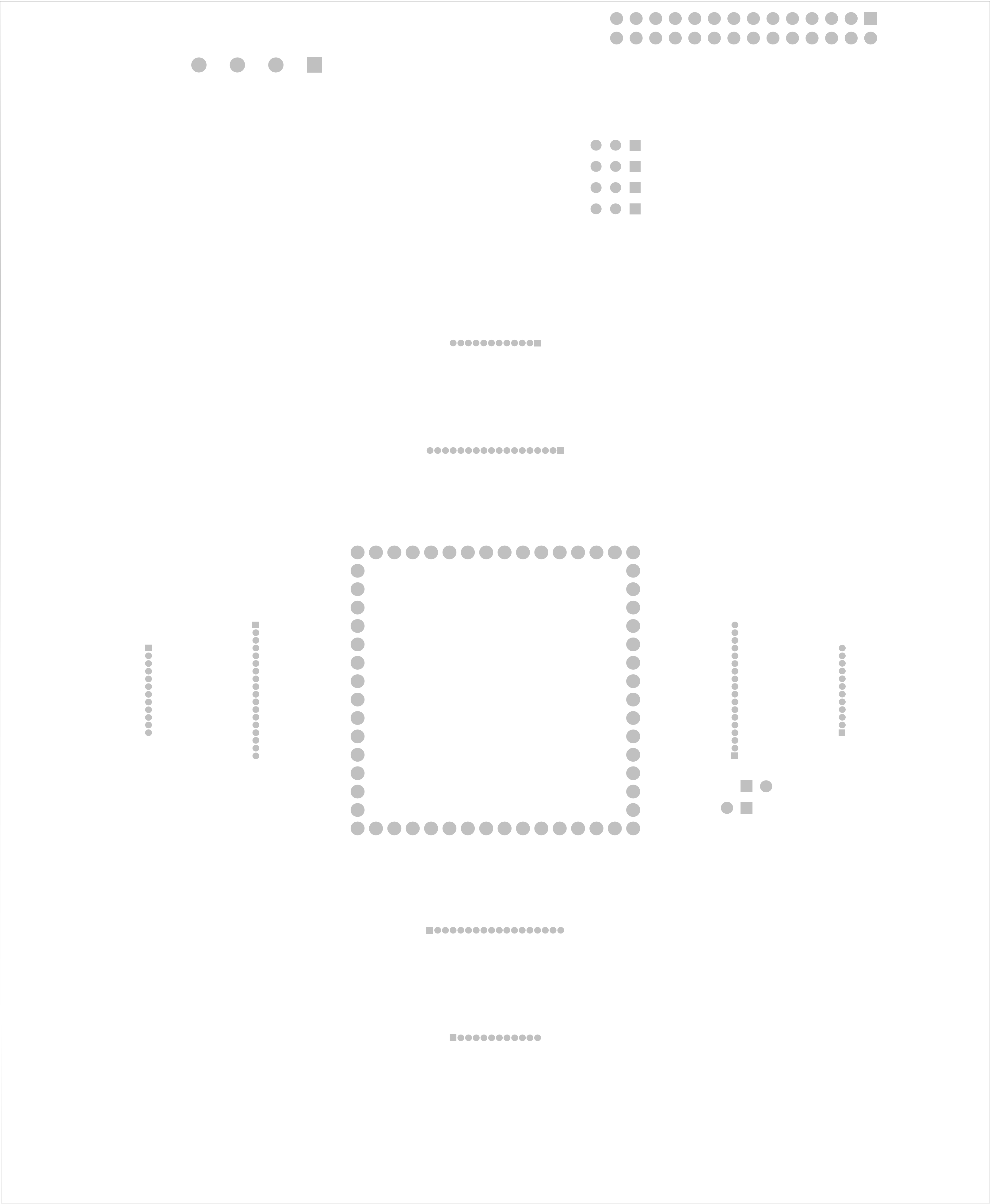
+

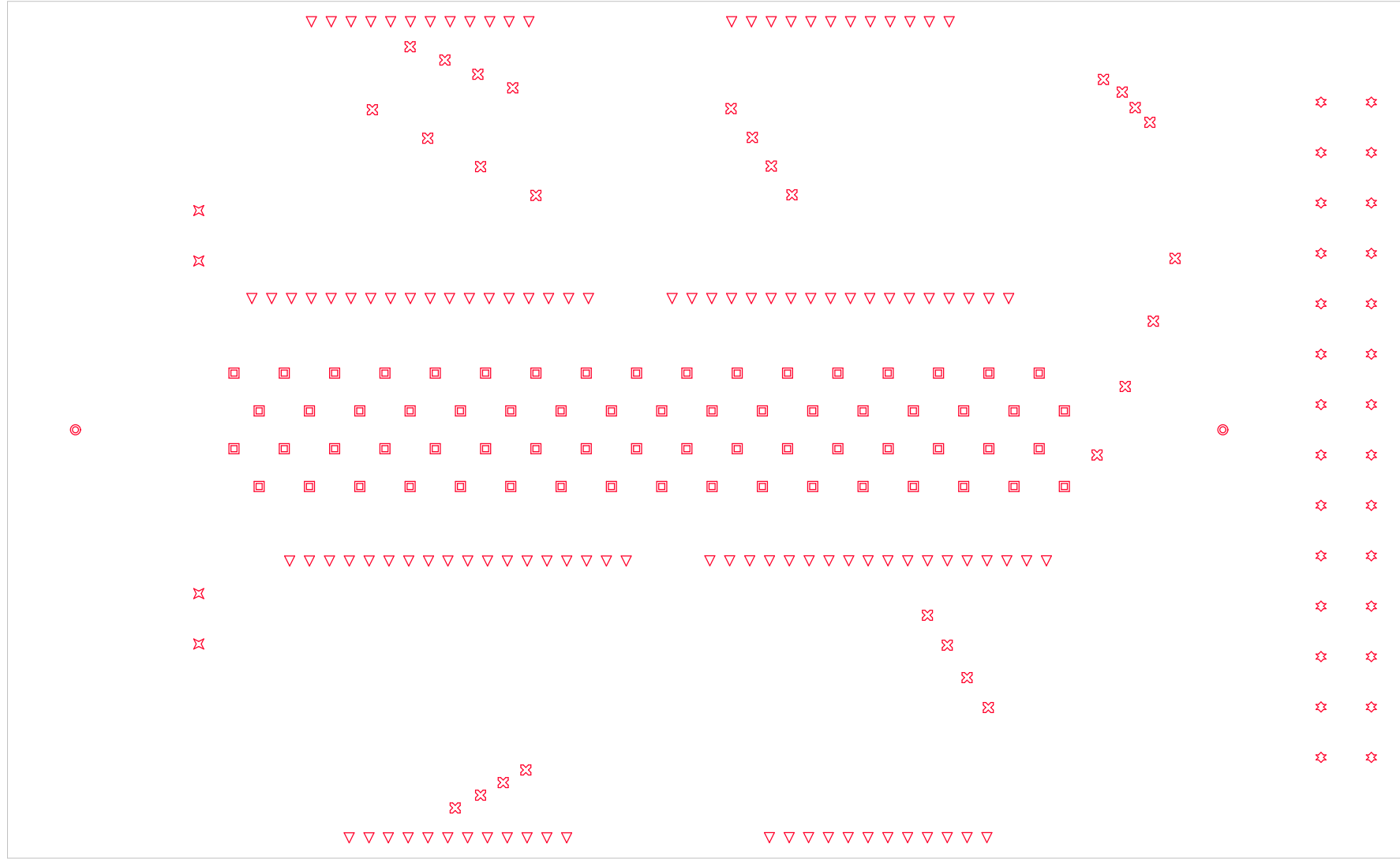
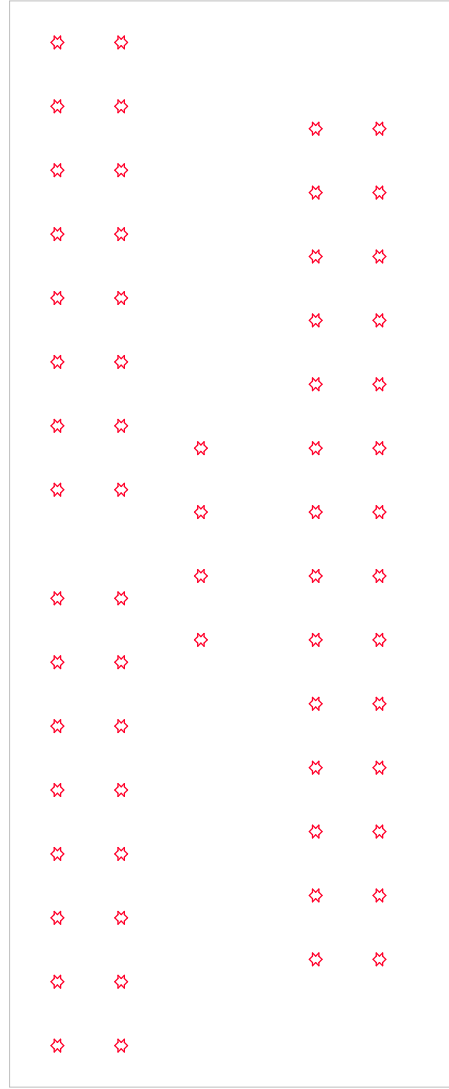
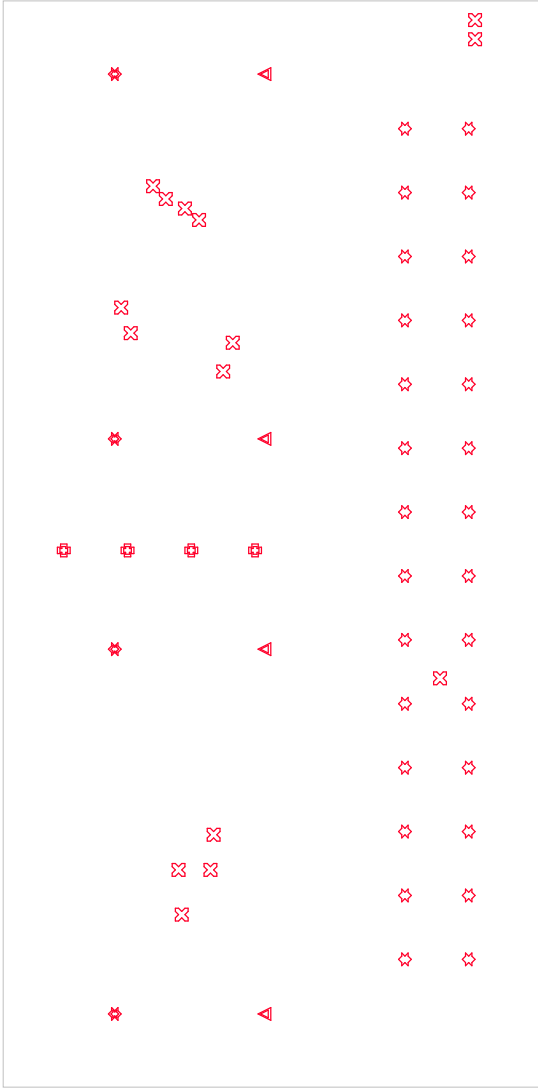
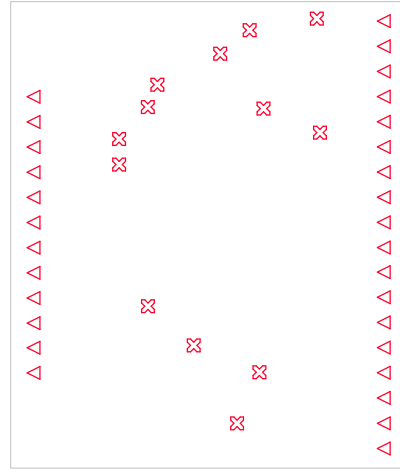
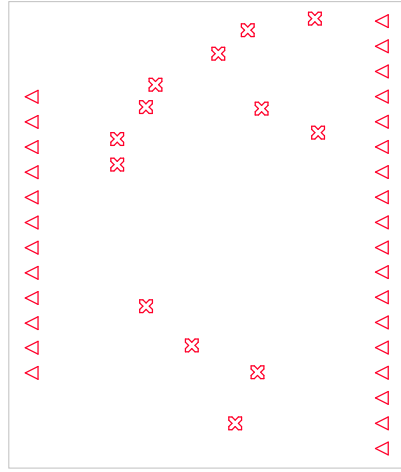
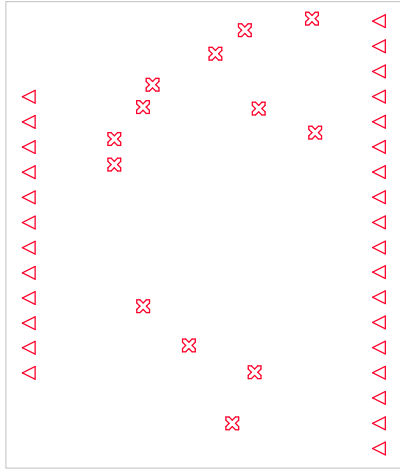
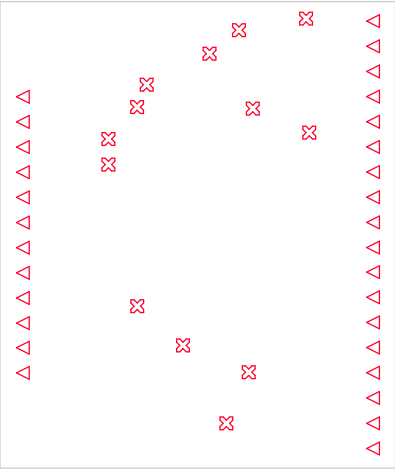
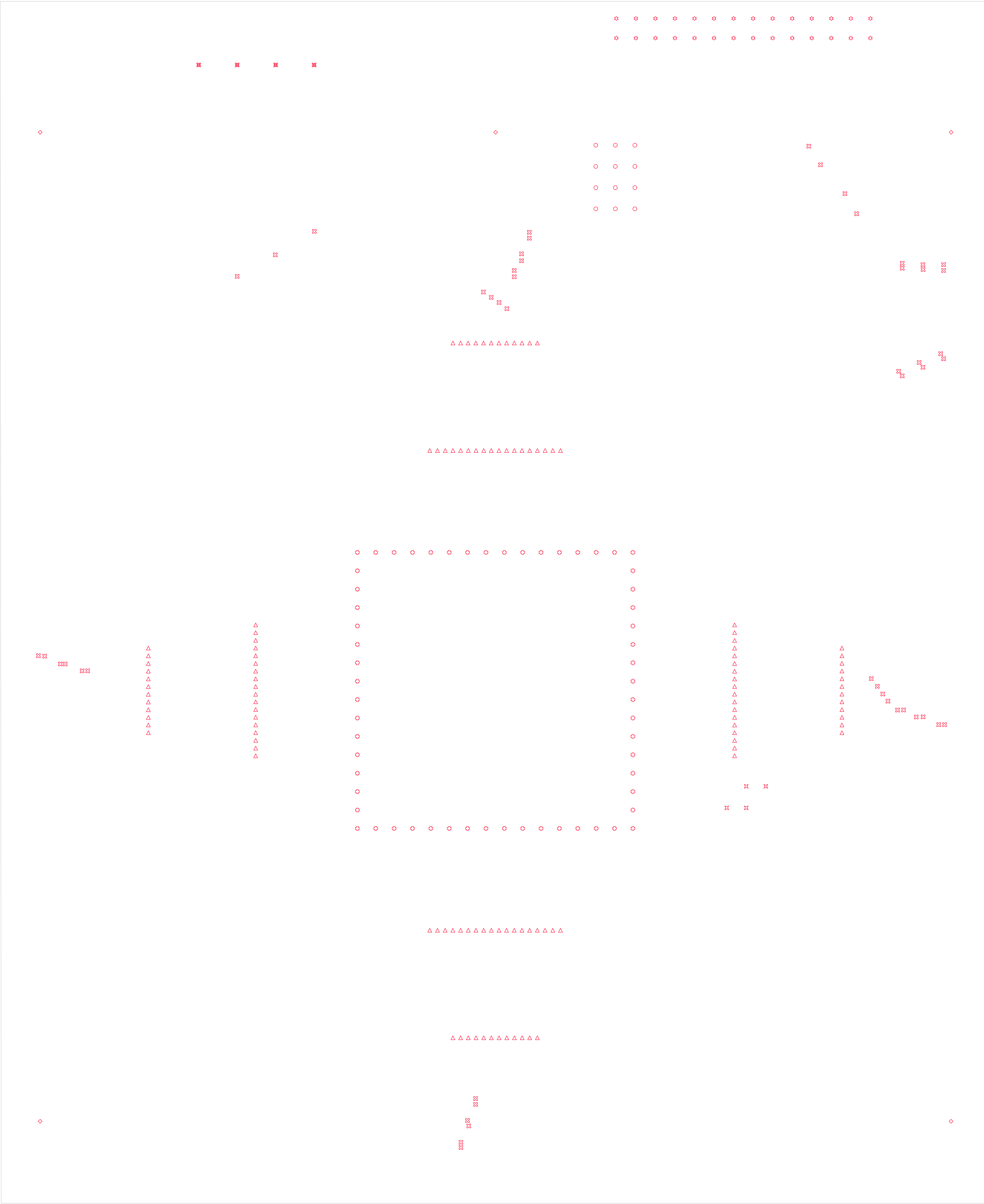
+

+

+







Designator	Comment	Manufacturer	Quantity	Footprint	Value
------------	---------	--------------	----------	-----------	-------